

Listing of Claims:

This listing of claims will replace all prior versions, and listings, of claims in the application:

1. (Previously Presented) A method for manufacturing a card comprising:
a step of forming a transfer sheet by directly forming an ink receiving layer on a base material sheet;
a step of inserting a transfer sheet into a cavity of a metal mold in a state where a surface of said ink receiving layer faces a room of said metal mold into which an injection-molding resin is injected;
a step of molding a card base by injecting said injection-molding resin into said cavity in a state where said transfer sheet is disposed in said cavity, and at the same time joining said ink receiving layer to said card base;
a step of taking out said card base joined by said ink receiving layer from said cavity;
a step of peeling said base material sheet from said transfer sheet in a manner that said ink receiving layer is left on said card base; and
a step of performing printing to said ink receiving layer after said card base is taken out from said cavity.
2. (Previously Presented) The method for manufacturing a card according to claim 1, wherein said ink receiving layer is formed of a heat-curable hydrophilic resin.
3. (Previously Presented) The method for manufacturing a card according to claim 1, characterized in that an anchor layer for enhancing airtightness of said ink receiving layer to said card base is pre-formed on said ink receiving layer.
4. (Canceled)
5. (Previously Presented) The method for manufacturing a card according to claim 1, wherein said printing is executed by an ink-jet printer.

6. (Previously Presented) The method for manufacturing a card according to claim 1, comprising a step of covering the surface of said ink receiving layer with a cover layer after printing is applied to said ink receiving layer.

7-12. (Canceled)